

# Three Phase Rectifier Bridge

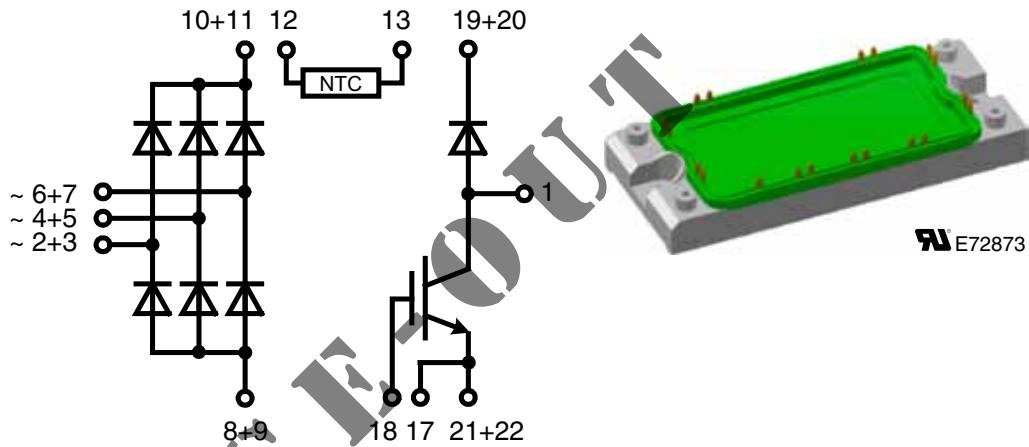
with IGBT and Fast Recovery Diode  
for Braking System

Rectifier Diode	Fast Recov. Diode	IGBT
$V_{RRM} = 1600 \text{ V}$	$V_{CES} = 1200 \text{ V}$	$V_{CES} = 1200 \text{ V}$
$I_{dAVM} = 145 \text{ A}$	$V_F = 2.76 \text{ V}$	$I_{C80} = 100 \text{ A}$
$I_{FSM} = 1100 \text{ A}$	$I_{FSM} = 200 \text{ A}$	$V_{CEsat} = 3.7 \text{ V}$

Preliminary data

**Part name** (Marking on product)

VUB145-16NO1



**Features:**

- Soldering connections for PCB mounting
- Convenient package outline
- Optional NTC

**Application:**

- Drive Inverters with brake system

**Package:**

- Two functions in one package
- Easy to mount with two screws
- Suitable for wave soldering
- High temperature and power cycling capability
- UL registered, E72873

**Recommended replacement:**

**VUB145-16NOXT**

## IGBT

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{CES}$	collector emitter voltage				1200	V
$V_{GES}$	max. DC gate voltage	continuous	-20		+20	V
$V_{GEM}$	max. transient collector gate voltage	transient	-30		+30	V
$I_{C25}$	collector current	DC	$T_c = 25^\circ C$		141	A
$I_{C80}$		DC	$T_c = 80^\circ C$		100	A
$P_{tot}$	total power dissipation		$T_c = 25^\circ C$		570	W
$V_{CE(sat)}$	collector emitter saturation voltage	$I_c = 150 A; V_{GE} = 15 V$	$T_{VJ} = 25^\circ C$		3.7	V
$V_{GE(th)}$	gate emitter threshold voltage	$I_c = 3 mA$	$T_{VJ} = 25^\circ C$	4.5	6.45	V
$I_{CES}$	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0 V$ $V_{CE} = 0.8 \cdot V_{CES}; V_{GE} = 0 V$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$		0.1 0.5	mA mA
$C_{ies}$	input capacitance	$V_{CE} = 25 V; V_{GE} = 0 V; f = 1 MHz$		5.7		nF
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 720 V; I_c = 75 A$ $V_{GE} = \pm 15 V; R_G = 15 \Omega; L = 100 \mu H$	$T_{VJ} = 125^\circ C$	80		ns
$t_{d(off)}$	turn-off delay time			680		ns
$E_{on}$	turn-on energy per pulse			9		mJ
$E_{off}$	turn-off energy per pulse			7.5		mJ
$I_{CM}$	reverse bias safe operating area	RBSOA; $V_{GE} = \pm 15 V; R_G = 15 \Omega; L = 100 \mu H$ clamped inductive load;	$T_{VJ} = 125^\circ C$		150	A
$V_{CEK}$					$\leq V_{CES} \cdot L_s \cdot d_i / dt$	V
$t_{sc}$ (SCSOA)	short circuit safe operating area	$V_{CE} = 720 V; V_{GE} = \pm 15 V; R_G = 15 \Omega$ ; non-repetitive	$T_{VJ} = 125^\circ C$		10	μs
RBSOA	reverse bias safe operating area	$V_{CE} = 1200 V; V_{GE} = \pm 15 V; R_G = 15 \Omega; L = 100 \mu H$ ; clamped inductive load	$T_{VJ} = 125^\circ C$		150	A
$R_{thJC}$	thermal resistance junction to case				0.22	K/W
$R_{thCH}$	thermal resistance case to heatsink				0.22	K/W

## Fast Recovery Diode

## Ratings

Symbol	Definitions	Conditions	min.	typ.	max.	Unit
$V_{RRM}$	max. repetitive reverse voltage		$T_{VJ} = 150^\circ C$		1200	V
$I_{FAV}$	average forward current	rect.; $d = 0.5$	$T_c = 80^\circ C$		27	A
$I_{FRMS}$	rms forward current	rect.; $d = 0.5$	$T_c = 80^\circ C$		38	A
$I_{FSM}$	max. surge forward current	$t = 10 ms$	$T_{VJ} = 45^\circ C$		200	A
$P_{tot}$	total power dissipation		$T_c = 25^\circ C$		130	W
$V_{FO}$	threshold voltage		$T_{VJ} = 150^\circ C$		1.3	V
$r_F$	slope resistance	for power loss calculation only			16	mΩ
$V_F$	forward voltage	$I_F = 30 A$	$T_{VJ} = 25^\circ C$		2.76	V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ C$ $T_{VJ} = 125^\circ C$	1	0.25	mA mA
$I_{RM}$	reverse recovery current	$I_F = 50 A; V_R = 100 V; di_F/dt = -100 A/\mu s$		5.5	11	A
$t_{rr}$	reverse recovery time	$I_F = 1 A; V_R = 30 V; di_F/dt = -200 A/\mu s$		40		ns
$R_{thJC}$	thermal resistance junction to case				0.9	K/W
$R_{thCH}$	thermal resistance case to heatsink				0.1	K/W

 $T_c = 25^\circ C$  unless otherwise stated

## Rectifier Diode

Symbol	Conditions		Ratings		
			min.	typ.	max.
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25^\circ\text{C}$		1600	V
$I_R$	reverse current	$V_R = V_{RRM}$	$T_{VJ} = 25^\circ\text{C}$ $T_{VJ} = 150^\circ\text{C}$	0.1 2	mA mA
$V_F$	forward voltage	$I_F = 150 \text{ A}$	$T_{VJ} = 25^\circ\text{C}$	1.68	V
$I_{D(AV)M}$	max. average DC output current	rectangular; $d = 1/3$ ; bridge	$T_C = 80^\circ\text{C}$	145	A
$V_{FO}$ $r_F$	threshold voltage slope resistance	for power loss calculation only	$T_{VJ} = 150^\circ\text{C}$	0.85 5.9	V mΩ
$R_{thJC}$	thermal resistance junction to case	per diode	$T_{VJ} = 25^\circ\text{C}$	0.5	K/W
$R_{thCH}$	thermal resistance case to heatsink		$T_{VJ} = 25^\circ\text{C}$	0.1	K/W
$P_{tot}$	total power dissipation		$T_{VJ} = 25^\circ\text{C}$	250	W
$I_{FSM}$	max. forward surge current	$t = 10 \text{ ms (50Hz)}$ $V_R = 0 \text{ V}$	$T_{VJ} = 45^\circ\text{C}$ $T_{VJ} = 150^\circ\text{C}$	1100 960	A A
$I^2t$	value for fusing	$t = 10 \text{ ms (50Hz)}$ $V_R = 0 \text{ V}$	$T_{VJ} = 45^\circ\text{C}$ $T_{VJ} = 150^\circ\text{C}$	6050 4610	A²s A²s

## Temperature Sensor NTC

Symbol	Definitions	Conditions		Ratings		
				min.	typ.	max.
$R_{25}$	resistance		$T_C = 25^\circ\text{C}$	4.75	5.0	5.25
$B_{25/85}$				3375		K

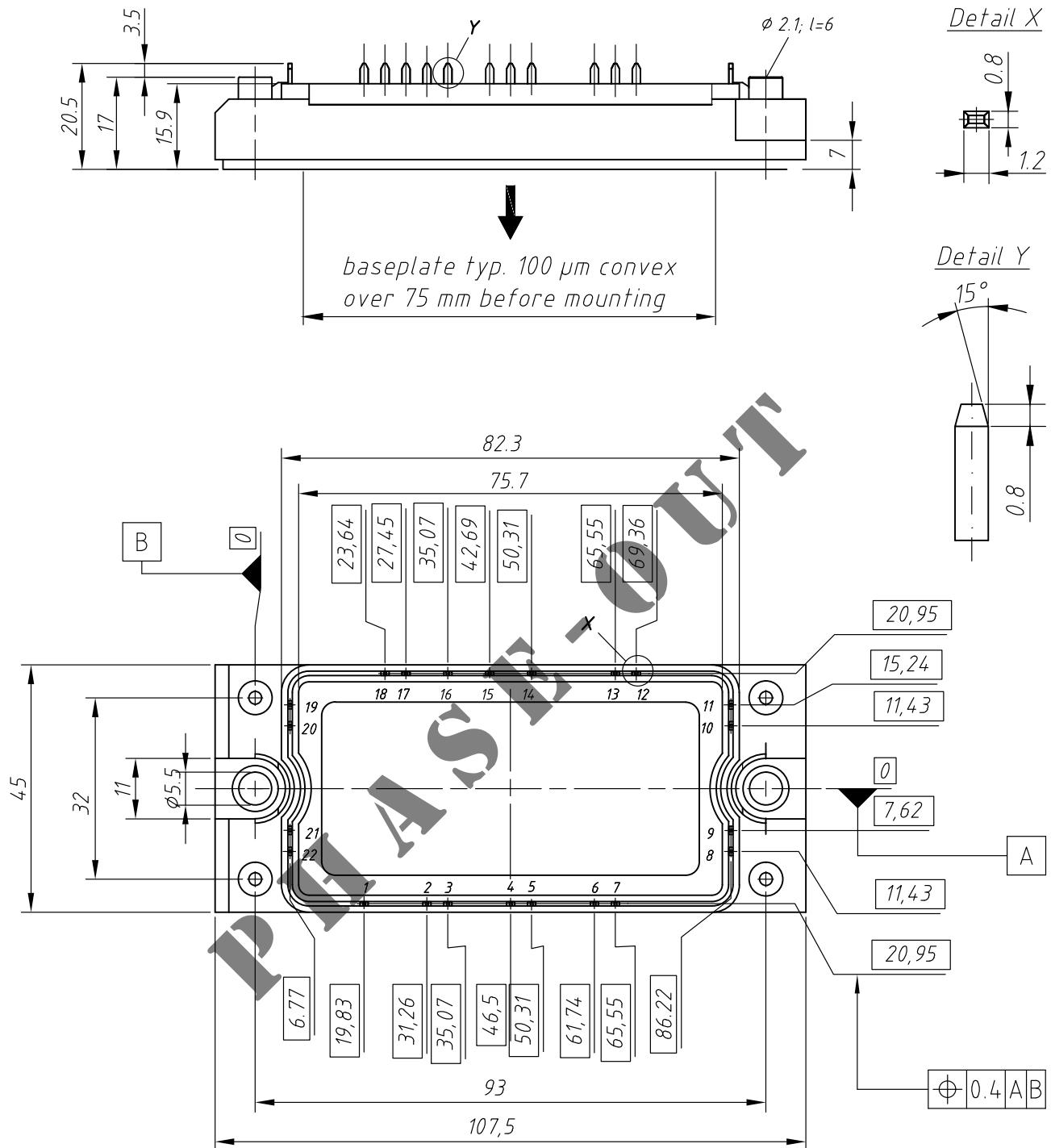
## Module

Symbol	Definitions	Conditions		Ratings		
				min.	typ.	max.
$T_{VJ}$	operating temperature		-40		125	°C
$T_{VJM}$	max. virtual junction temperature				150	°C
$T_{stg}$	storage temperature		-40		125	°C
$V_{ISOL}$	isolation voltage	$I_{ISOL} \leq 1 \text{ mA}; 50/60 \text{ Hz};$ $t = 1 \text{ min.}$ $t = 1 \text{ s}$			2500 3000	V~ V~
$M_d$	mounting torque	(M5)	2.7		3.3	Nm
$d_s$	creep distance on surface		12.7			mm
$d_A$	strike distance through air		9.6			mm
$a$	maximum allowable acceleration		50			m/s²
$R_{pin-chip}$	thermal resistance pin to chip	$T_{VJ} = 25^\circ\text{C}$		2		mΩ
Weight				180		g

 $T_C = 25^\circ\text{C}$  unless otherwise stated

## Outline Drawing

Dimensions in mm (1 mm = 0.0394")



## Product Marking

Ordering	Part Name	Marking on Product	Delivering Mode	Base Qty	Ordering Code
Standard	VUB 145-16NO1	VUB145-16NO1	Box	6	496669

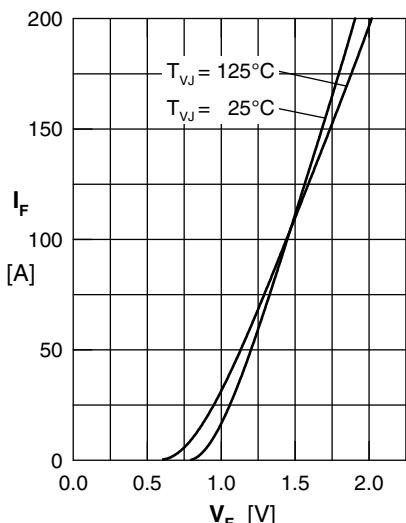


Fig. 1 Forward current vs. voltage drop per diode

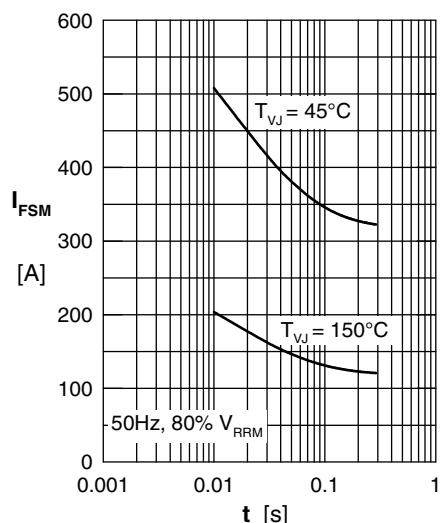


Fig. 2 Surge overload current

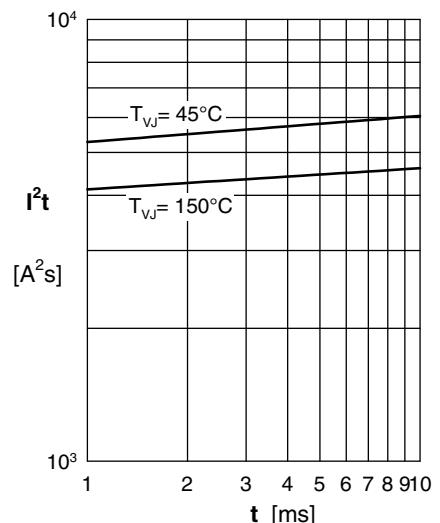


Fig. 3  $I^2t$  versus time per diode

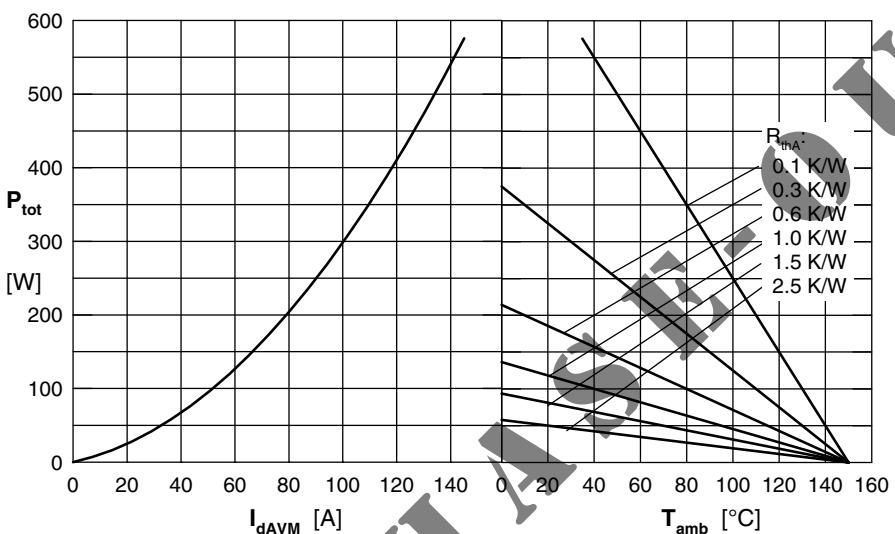


Fig. 4 Power dissipation versus direct output current and ambient temperature, sine 180°

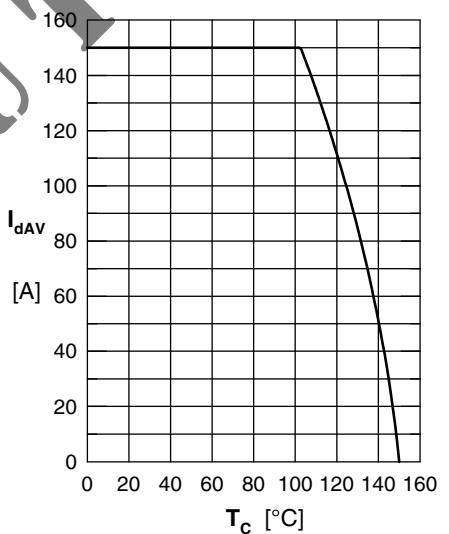


Fig. 5 Max. forward current vs. case temperature

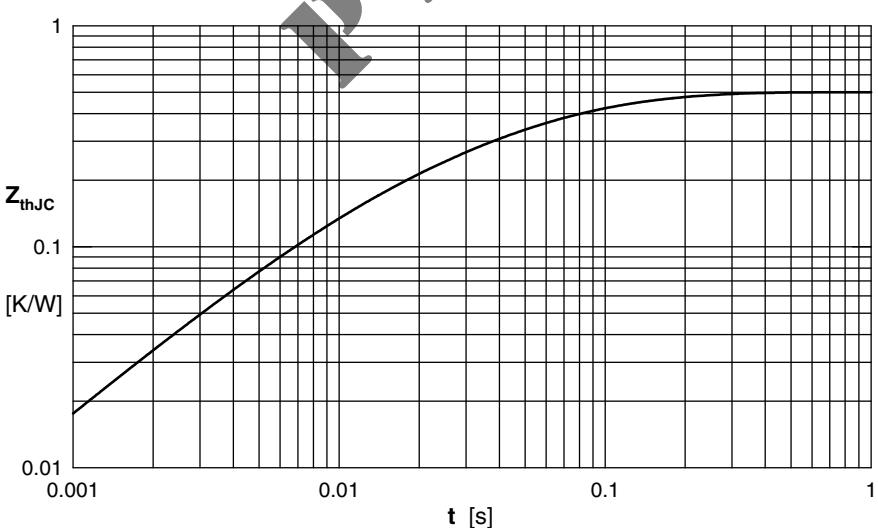


Fig. 6 Transient thermal impedance junction to case

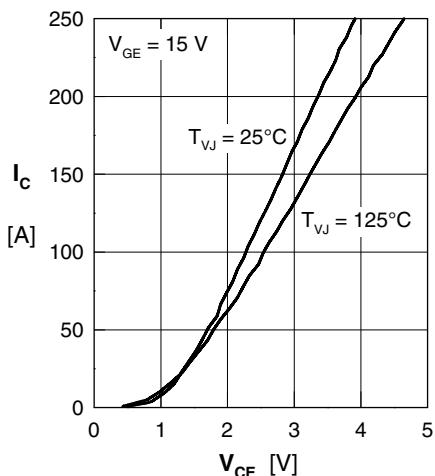


Fig. 7 Typ. output characteristics

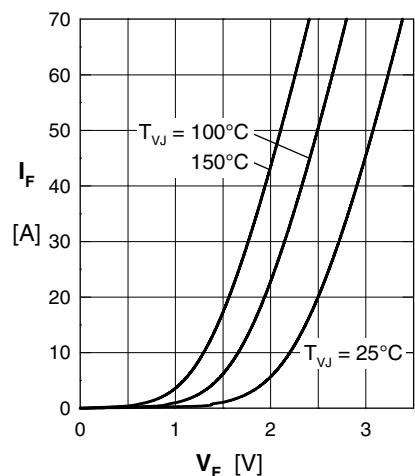


Fig. 8 Typ. forward characteristics of free wheeling diode

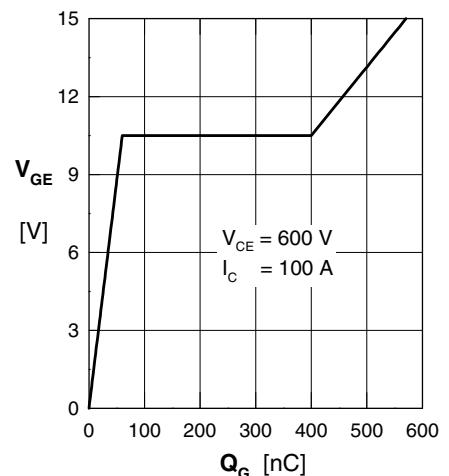


Fig. 9 Typ. turn on gate charge

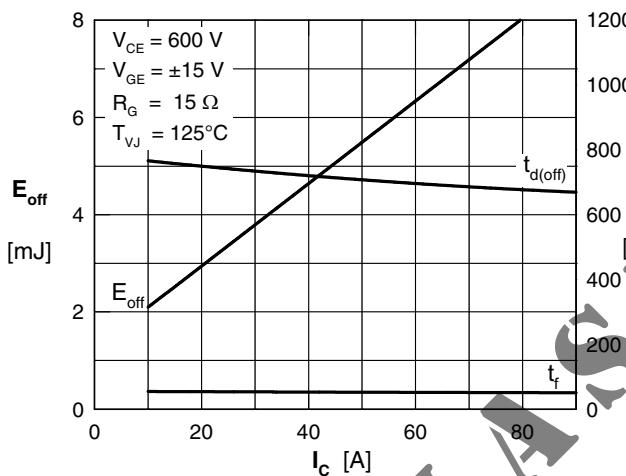


Fig. 10 Typ. turn off energy and switching times versus collector current

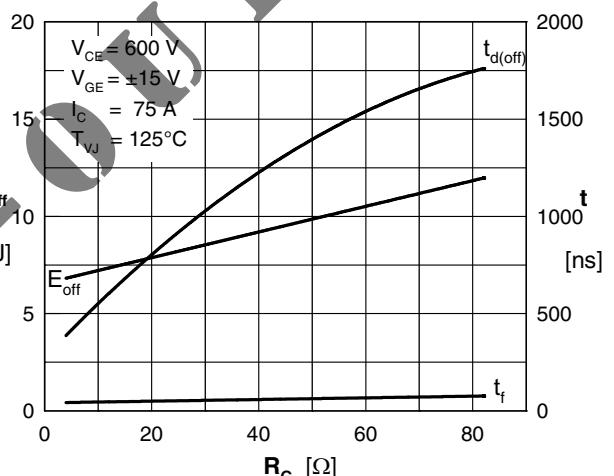


Fig. 11 Typ. turn off energy and switching times versus gate resistor

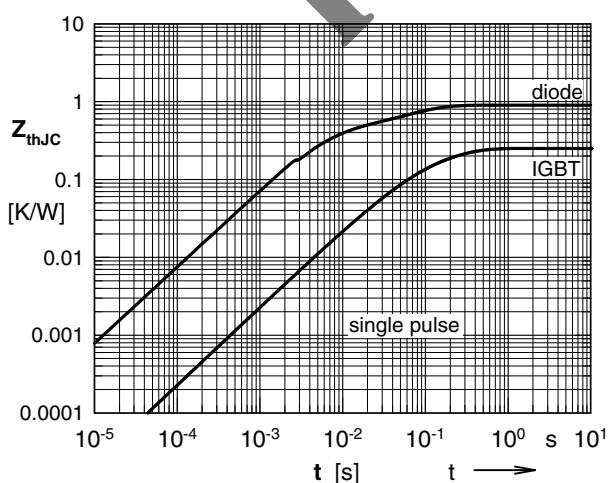


Fig. 12 Typ. transient thermal impedance

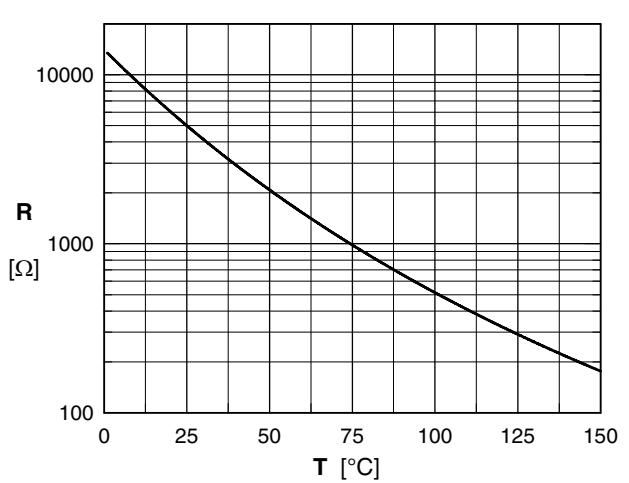


Fig. 13 Typ. thermistor resistance vs. temperature